



Power MOSFETS

DATASHEET

LM40013NHM8A

N-Channel
Enhancement Mode MOSFET

- Leadpower-semi CO., LTD.
- sales@leadpower-semi.com
- (03) 6577339 FAX : (03) 6577229
- www.leadpower-semi.com



Quality Management Systems
ISO 9001:2015 Certificate

N-Channel Enhancement Mode MOSFET

Pin Description

LFPACK56		Symbol	Symbol	N-Channel	Unit
Top view	Bottom view				
				40	V
				1.1	mΩ
				259	A

Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and Rg Tested
- Moisture Sensitivity Level MSL1

Applications

- DC-to-DC converters
- Switch Mode Power Supply
- Brushless DC motor control

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM40013NHN8A	LFPACK56	Tape & Reel	4000 / Tape & Reel	40013

Note : = Lot Code

Absolute Maximum Ratings ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
V_{DSS}	Drain-Source Voltage	40	V
V_{GSS}	Gate-Source Voltage	± 20	
T_J	Maximum Junction Temperature	175	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 175	$^\circ\text{C}$
I_S	Diode Continuous Forward Current	$T_c=25^\circ\text{C}$	A
I_{SP}	Diode Pulse Current	$T_c=25^\circ\text{C}$	$400^{\circ\text{C}}$
I_{DM}	Pulse Drain Current Tested	$T_c=25^\circ\text{C}$	$646^{\circ\text{C}}$
I_D	Continuous Drain Current	$T_c=25^\circ\text{C}$	A
		$T_c=100^\circ\text{C}$	183
P_D	Maximum Power Dissipation	$T_c=25^\circ\text{C}$	W
		$T_c=100^\circ\text{C}$	63
I_D	Continuous Drain Current	$T_A=25^\circ\text{C}$	A
		$T_A=70^\circ\text{C}$	35
P_D	Maximum Power Dissipation	$T_A=25^\circ\text{C}$	W
		$T_A=70^\circ\text{C}$	1.8
$I_{AS}^{\circ\text{C}}$	Avalanche Current, Single pulse	$L=0.1\text{mH}$	A
		$L=0.5\text{mH}$	60
$E_{AS}^{\circ\text{C}}$	Avalanche Energy, Single pulse	$L=0.1\text{mH}$	32 mJ
		$L=0.5\text{mH}$	180
			256

Thermal Characteristics

Symbol	Parameter	Rating	Unit
R_{JC}	Thermal Resistance-Junction to Case	Steady State	1.2 $^\circ\text{C/W}$
$R_{JA}^{\circ\text{C}}$	Thermal Resistance-Junction to Ambient	Steady State	45 $^\circ\text{C/W}$

Note ① : Max. current is limited by junction temperature

Note ② : UIS tested and pulse width are limited by maximum junction temperature 175°C

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz

LM40013NHM8A

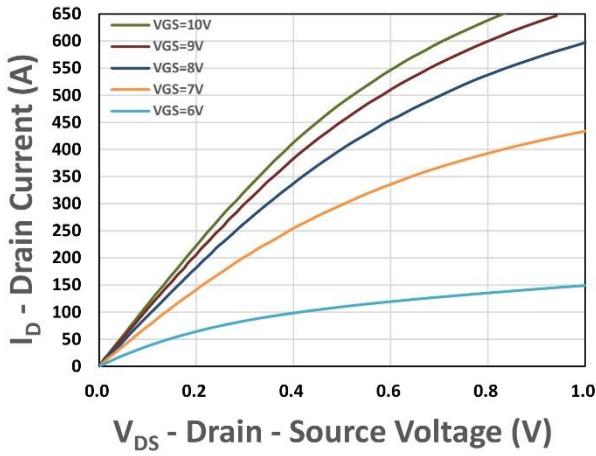
N-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{DS}}=250\mu\text{A}$	40	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=32\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	1	μA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{DS}}=250\mu\text{A}$	2	3	4	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
$R_{\text{DS(ON)}}^{\circledast}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$, $I_{\text{DS}}=20\text{A}$	-	0.9	1.1	$\text{m}\Omega$
g_{fs}	Forward Transconductance	$V_{\text{DS}}=5\text{V}$, $I_{\text{DS}}=10\text{A}$	-	46	-	S
Dynamic Characteristics ^⑤						
R_{G}	Gate Resistance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, Freq.=1MHz	-	1	-	Ω
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=20\text{V}$, Freq.=1MHz	-	4954	-	pF
C_{oss}	Output Capacitance		-	1543	-	
C_{rss}	Reverse Transfer Capacitance		-	98	-	
$t_{\text{d(ON)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=20\text{V}$, $I_{\text{D}}=1\text{A}$, $R_{\text{GEN}}=1\Omega$	-	20	-	nS
t_{r}	Turn-on Rise Time		-	12	-	
$t_{\text{d(OFF)}}$	Turn-off Delay Time		-	40	-	
t_{f}	Turn-off Fall Time		-	97	-	
Q_{g}	Total Gate Charge	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=20\text{V}$, $I_{\text{D}}=20\text{A}$	-	64	-	nC
Q_{gs}	Gate-Source Charge		-	26	-	
Q_{gd}	Gate-Drain Charge		-	9.9	-	
Source-Drain Characteristics						
$V_{\text{SD}}^{\circledast}$	Diode Forward Voltage	$I_{\text{SD}}=10\text{A}$, $V_{\text{GS}}=0\text{V}$	-	0.75	1.1	V
t_{rr}	Reverse Recovery Time	$I_{\text{F}}=10\text{A}$, $V_{\text{R}}=20\text{V}$ $dI_{\text{F}}/dt=100\text{A}/\mu\text{s}$	-	61	-	nS
Q_{rr}	Reverse Recovery Charge		-	52	-	nC

Note ④ : Pulse test (pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$).

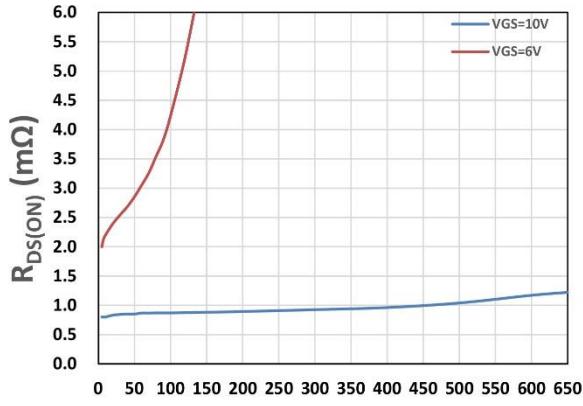
Note ⑤ : Guaranteed by design, not subject to production testing.

N-Channel Typical Characteristics



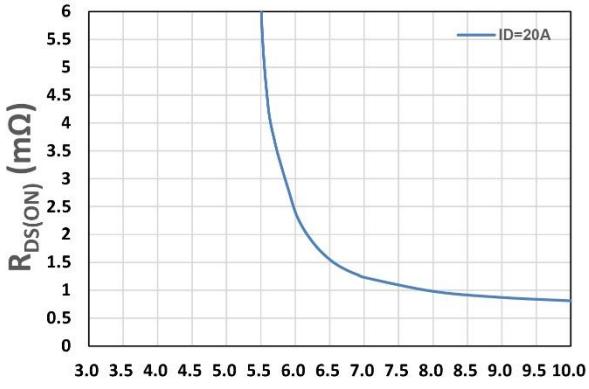
I_D - Drain Current (A)

Figure 1. Output Characteristics



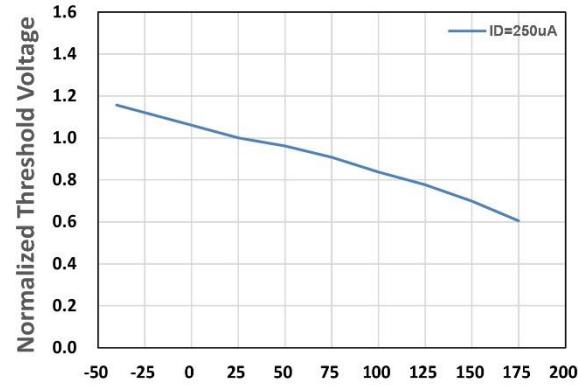
I_D - Drain Current (A)

Figure 2. On-Resistance vs. ID



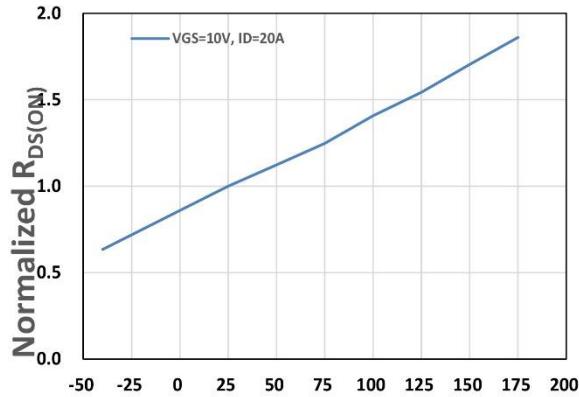
V_{GS} - Gate - Source Voltage (V)

Figure 3. On-Resistance vs. VGS



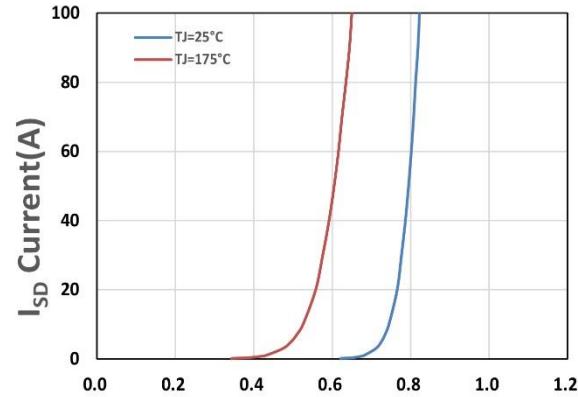
T_j , Junction Temperature(°C)

Figure 4. Gate Threshold Voltage



T_j , Junction Temperature(°C)

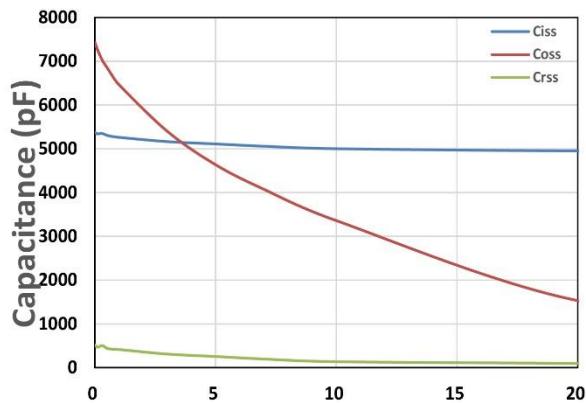
Figure 5. Drain-Source On Resistance



V_{SD} , Source-Drain Voltage(V)

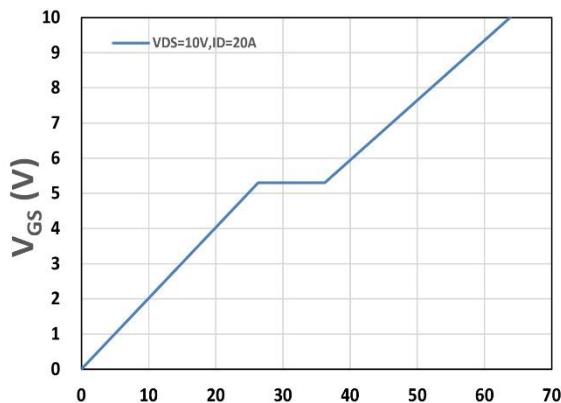
Figure 6. Source-Drain Diode Forward

LM40013NHM8A



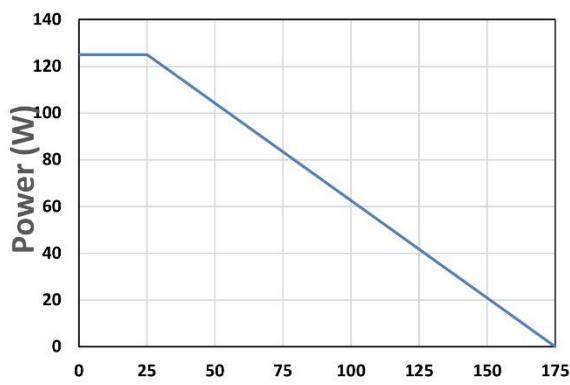
V_{DS} - Drain - Source Voltage (V)

Figure 7. Capacitance



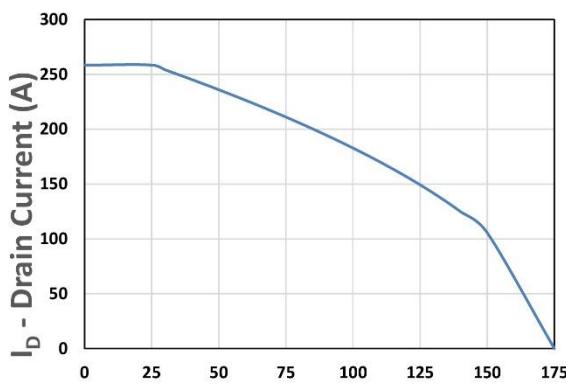
Q_g , Total Gate Charge (nC)

Figure 8. Gate Charge Characteristics



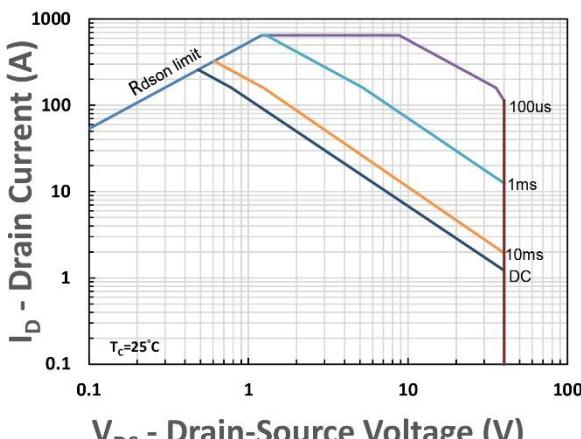
T_c - Case Temperature (°C)

Figure 9. Power Dissipation



T_c - Case Temperature (°C)

Figure 10. Drain Current



V_{DS} - Drain-Source Voltage (V)

Figure 11. Safe Operating Area

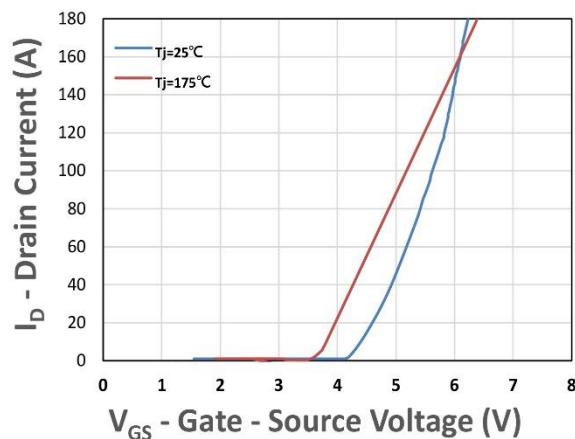


Figure 12. Transfer Characteristics

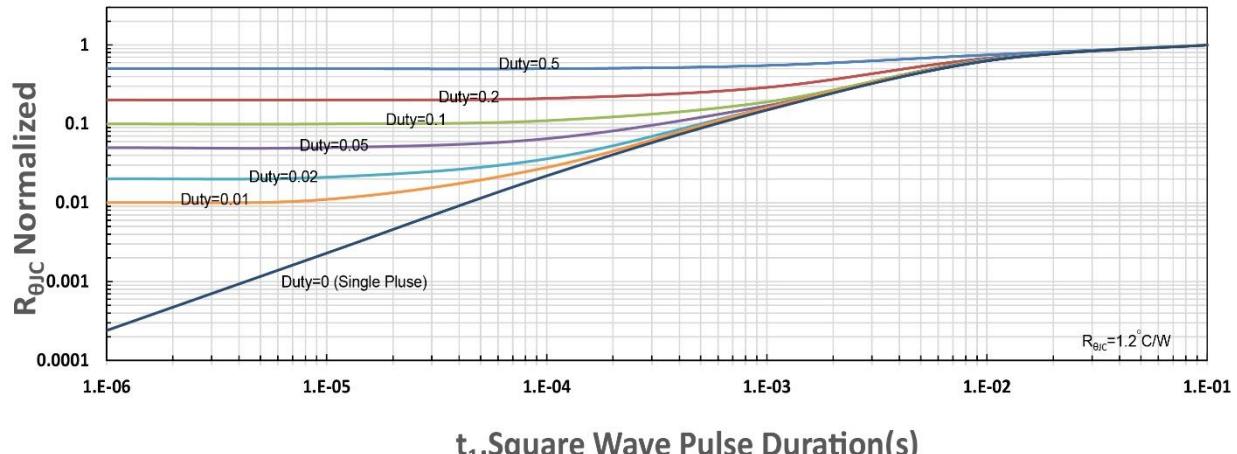


Figure 13. $R_{\theta JC}$ Transient Thermal Impedance